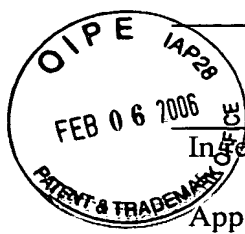


IFW



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Nikhil Vishwanath Kelkar

Attorney Docket No.:  
NSC1P300/P05882

Application No.: 10/824,903

Examiner: Shankle, A.

Filed: April 14, 2004

Group: 2891

Title: WAFER LEVEL PACKAGE DESIGN  
THAT FACILITATES TRIMMING AND  
TESTING

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on February 2, 2006 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed:   
Lara M. Nelson

**RESPONSE TO RESTRICTION REQUIREMENT**

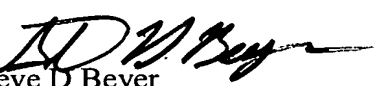
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Restriction Requirement dated January 19, 2006, Applicant hereby elects, **with** traverse, group I, claims 1-9 to prosecute in the above-identified patent application.

If any fees are due in connection with the filing this Response to Restriction Requirement, the Commissioner is hereby authorized to charge such fees to Deposit Account 500388 (Order No. NSC1P300).

Respectfully submitted,  
BEYER WEAVER & THOMAS, LLP

  
Steve D Beyer  
Registration No. 31,234

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